TEMT7000X01

Vishay Semiconductors

Silicon Phototransistor in 0805 Package



www.vishay.com

DESCRIPTION

TEMT7000X01 is a high speed silicon NPN epitaxial planar phototransistor in a miniature 0805 package for surface mounting on printed boards. The device is sensitive to visible and near infrared radiation.

FEATURES

- · Package type: surface-mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- · High photo sensitivity
- High radiant sensitivity
- Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Package matched with IR emitter series VSMB1940X01
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Detector in automotive applications
- Light sensors
- · Radiation sensors

PRODUCT SUMMARY				
COMPONENT	I _{ca} (μA) at E _e = 1 mW/cm ² , λ = 950 nm, V _{CE} = 5 V	φ (°)	λ _{0.1} (nm)	
TEMT7000X01	225 to 675	± 60	470 to 1090	

Note

Test condition see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TEMT7000X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		V _{CEO}	20	V
Emitter collector voltage		V _{ECO}	7	V
Collector current		Ι _C	20	mA
Power power dissipation	$T_{amb} \le 55 \ ^{\circ}C$	Pv	100	mW
Junction temperature		Тj	100	°C
Operating temperature range		T _{amb}	-40 to +100	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	According to reflow profile Fig. 8	T _{sd}	260	°C
Thermal resistance junction-to-ambient	According to J-STD-051	R _{thJA}	270	K/W

Document Number: 81961



RoHS COMPLIANT HALOGEN

e

FREE GREEN (5-2008)





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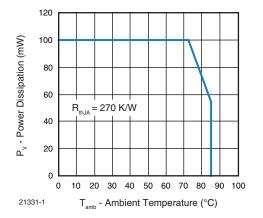


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	I _C = 0.1 mA	V _{CEO}	20	-	-	V
Collector dark current	$V_{CE} = 5 V, E = 0$	I _{CEO}	-	1	100	nA
Collector emitter capacitance	$V_{CE} = 0 V, f = 1 MHz, E = 0$	C _{CEO}	-	25	-	pF
Collector light current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$, $V_{CE} = 5 \text{ V}$	I _{CA}	225	450	675	μA
Angle of half sensitivity		φ	-	± 60	-	0
Wavelength of peak sensitivity		λρ	-	850	-	nm
Range of spectral bandwidth		λ _{0.1}	-	470 to 1090	-	nm
Collector emitter saturation voltage	I _C = 0.05 mA	V _{CEsat}	-	-	0.4	V
Temperature coefficient of Ica	$\begin{array}{l} E_{\mathrm{e}} = 1 \ \mathrm{mW/cm^2}, \lambda = 950 \ \mathrm{nm}, \\ V_{\mathrm{CE}} = 5 \ \mathrm{V} \end{array}$	Tk _{lca}	-	1.1	-	%/K

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

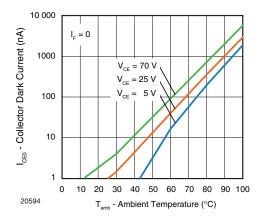
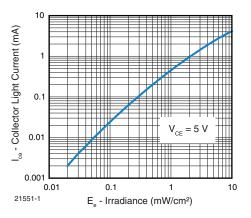


Fig. 2 - Collector Dark Current vs. Ambient Temperature





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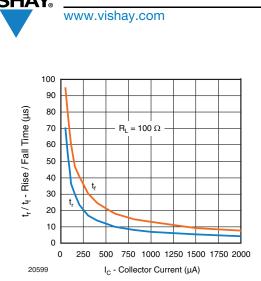


Fig. 4 - Rise/Fall Time vs. Collector Current

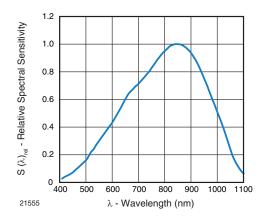
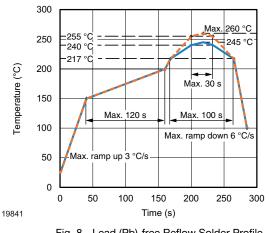


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength



REFLOW SOLDER PROFILE

Fig. 8 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

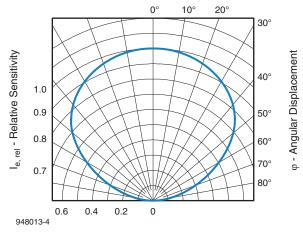


Fig. 6 - Relative Sensitivity vs. Angular Displacement

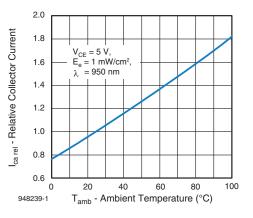


Fig. 7 - Relative Collector Current vs. Ambient Temperature

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label: Floor life: 168 h Conditions: $T_{amb} < 30$ °C, RH < 60 % Moisture sensitivity level 3, acc. to J-STD-033D.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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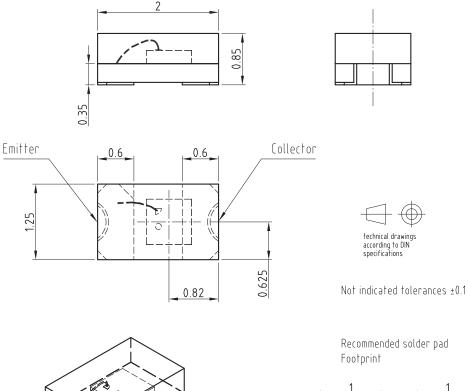


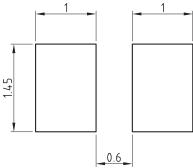
PACKAGE DIMENSIONS in millimeters

Drawing-No.: 6.541-5063.01-4

Issue: 3; 23.02.07

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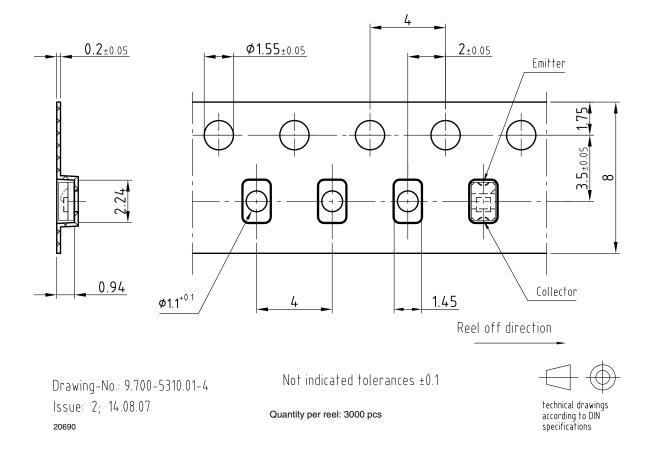






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BLISTER TAPE DIMENSIONS in millimeters

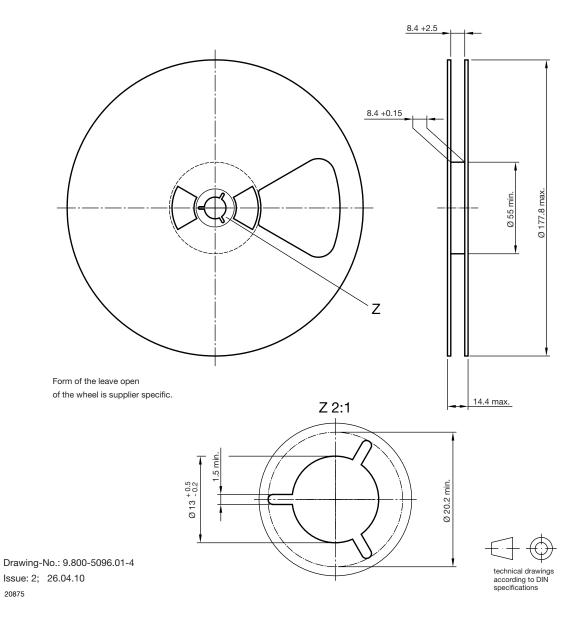






REEL DIMENSIONS in millimeters

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